



SAMSUNG ELECTRONICS AMERICA, INC.
American QA Lab
19 Chapin Rd. Building D
Pine Brook, NJ 07058

Date: May. 30, 2017

FCC ID: A3LSMJ701F

We attest that

DC-HSDPA : B2 Subset 3/4 mostly higher than the tune up power with MPR

H S U P A : B 5 Subset 1 mostly lower than the tune up power with MPR

@ Developer's opinion.

It is expected by manufacturer that MPR for some HSPA subtests may be up to 2dB more than specified by 3GPP, but also as low as 0 dB according to the chipset implementation in this model. The HSPA transmitter power will not exceed the R99 maximum transmit Power in this device

Sincerely,

A handwritten signature in black ink, appearing to read "D. Seol" with a stylized flourish at the end.

DONGBEOM SEOL

General Manager

Samsung Electronics CO. LTD

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